

LOW POWER, BAND-GAP VOLTAGE REFERENCES

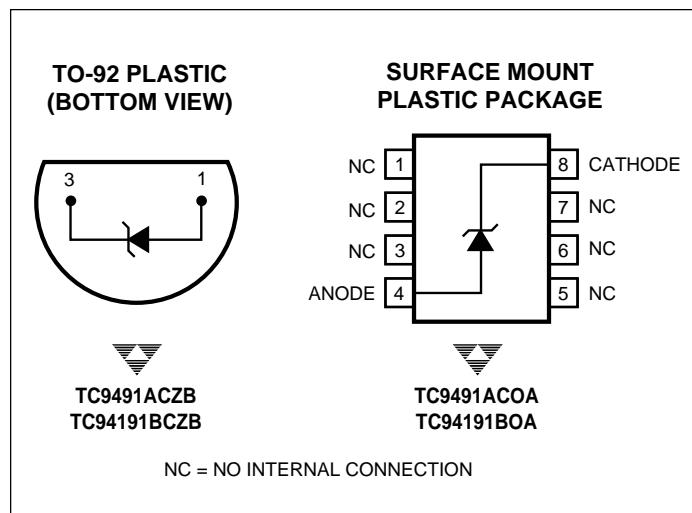
FEATURES

- Temperature Coefficient 50ppm/ $^{\circ}\text{C}$
- Wide Operating Current Range 15 μA to 20mA
- Dynamic Impedance 0.6 Ω
- Output Tolerance 1% or 2%
- Output Voltage Option 1.220V
- TO-92 Plastic Package
- 8-Pin Plastic Small Outline (SO) Package

APPLICATIONS

- ADC and DAC Reference
- Current Source Generation
- Threshold Detectors
- Power Supplies
- Multi-meters

PIN CONFIGURATIONS



GENERAL DESCRIPTION

The TC9491 (1.220V output) bipolar, two-terminal, band-gap voltage references offer precision performance without premium price. These devices do not require thin-film resistors, greatly lowering manufacturing complexity and cost.

A 50ppm/ $^{\circ}\text{C}$ output temperature coefficient and a 15 μA to 20mA operating current range make these devices attractive for multimeter, data acquisition converter, and telecommunication voltage references.

ORDERING INFORMATION

Part No.	Package	Temperature Range	Temp.Co.
TC9491ACOA	8-Pin SOIC	0°C to +70°C	50 ppm $^{\circ}\text{C}$
TC9491BCOA	8-Pin SOIC	0°C to +70°C	100 ppm $^{\circ}\text{C}$
TC9491ACZM	TO-92	0°C to +70°C	50 ppm $^{\circ}\text{C}$
TC9491BCZM	TO-92	0°C to +70°C	100 ppm $^{\circ}\text{C}$

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TC9491A TC9491B

ABSOLUTE MAXIMUM RATINGS*

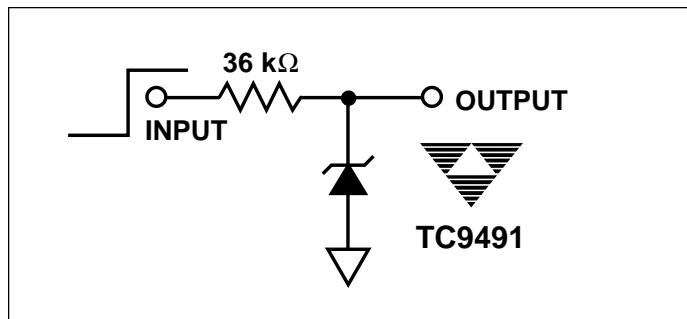
Forward Current	+10mA
Reverse Current	+30mA
Storage Temperature Range	-65°C to +150°C
Operating Temperature Range	
TO-92 Package	0°C to +70°C
COA Surface Mount Package	0°C to +70°C
Lead Temperature (Soldering, 10 sec)	
TO-92 Package	+300°C
COA Surface Mount Package	+300°C
Power Dissipation	
Limited by Forward/Reverse Current	

*Functional operation above the absolute maximum stress ratings is not implied.

ELECTRICAL CHARACTERISTICS: $T_A = +25^\circ\text{C}$, unless otherwise specified.

Symbol	Parameter	Test Conditions	TC9491A			TC9491B			Unit
			Min	Typ	Max	Min	Typ	Max	
$V_{(\text{BR})R}$	Reverse Breakdown Voltage $T_A = 0^\circ\text{C}$ to $+70^\circ\text{C}$	$I_R \leq 20\text{mA}$	1.200 1.180	1.22 —	1.250 1.290	1.200 1.219	1.220 —	1.250 1.260	V
I_{RMIN}	Minimum Operating Current $T_A = +25^\circ\text{C}$ $T_A = 0^\circ\text{C}$ to $+70^\circ\text{C}$		— —	8.0 —	15 20	— —	8.0 —	15 20	μA
$\Delta V_{(\text{BR})R}$	Reverse Breakdown Voltage Change with Current $I_{\text{Rmin}} = I_R = 1.0\text{mA}$, $T_A = +25^\circ\text{C}$ $T_A = 0^\circ\text{C}$ to $+70^\circ\text{C}$ $1.0\text{mA} = I_R = 20\text{mA}$, $T_A = +25^\circ\text{C}$ $T_A = 0^\circ\text{C}$ to $+70^\circ\text{C}$		— — — —	— — — —	1.0 1.5 10 20	— — — —	— — — —	1.0 1.5 20 25	mV
Z	Reverse Dynamic Impedance	$I_R = 100\mu\text{A}$	—	0.6	—	—	0.6	—	Ω
$\Delta V_{(\text{BR})}/\Delta T$	Average Temperature Coefficient	$10\mu\text{A} = I_R = 20\text{mA}$	—	—	50	—	—	100	$\text{ppm}/^\circ\text{C}$
S	Long Term Stability	$I_R = 100\mu\text{A}$, $T_A = +25^\circ\text{C} \pm 0.1^\circ\text{C}$	—	20	—	—	20	—	ppm/kHR

RESPONSE TIME TEST CIRCUIT

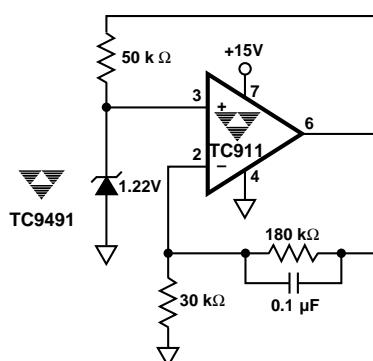


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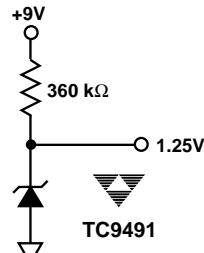
**TC9491A
TC9491B**

TYPICAL APPLICATIONS

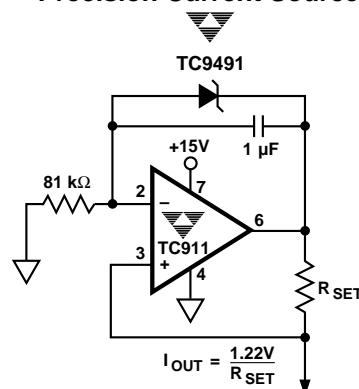
10V Reference



Battery Powered 1.25V Reference

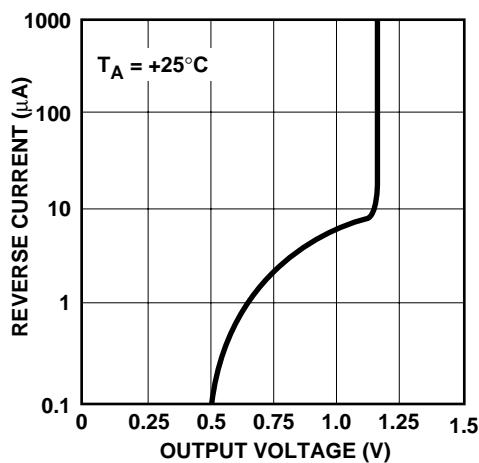


Precision Current Source

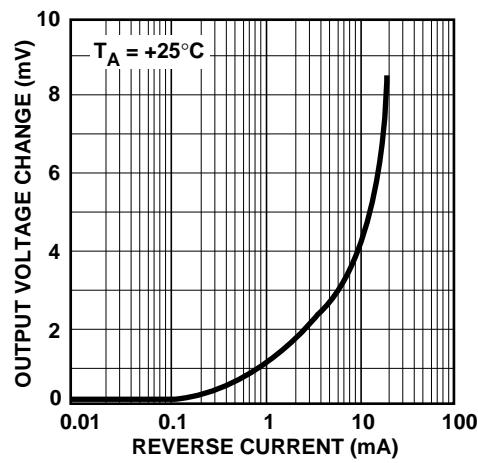


TYPICAL CHARACTERISTICS

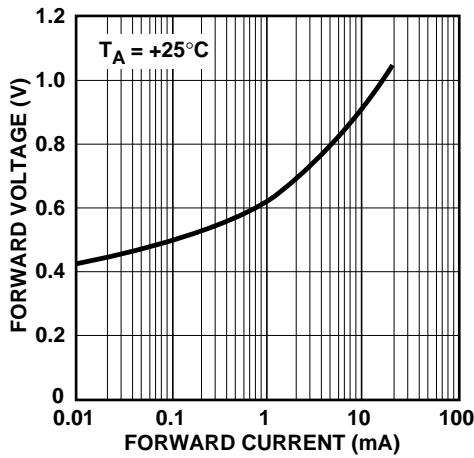
Output Voltage vs. Reverse Current



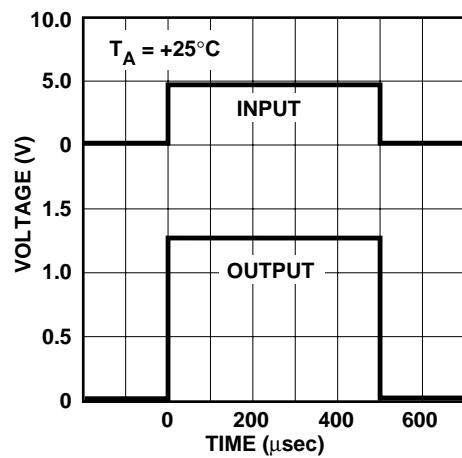
Output Voltage Change vs. Reverse Current



Forward Voltage vs. Forward Current



Response Time

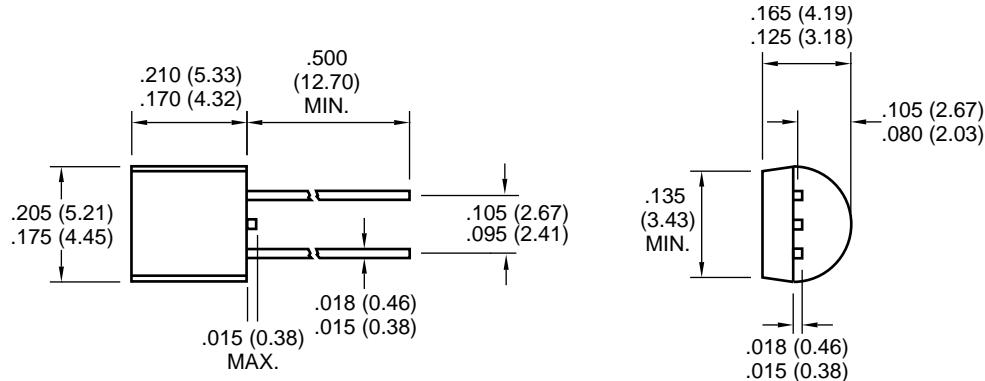


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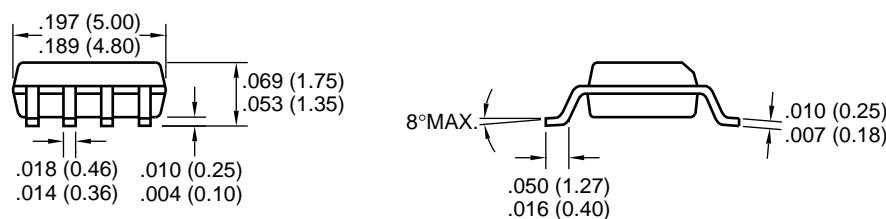
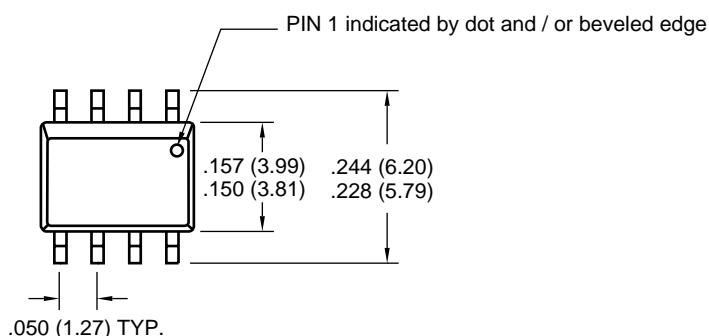
TC9491A
TC9491B

PACKAGE DIMENSIONS

TO-92-2



8-Pin SOIC



Dimensions: inches (mm)

Sales Offices

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